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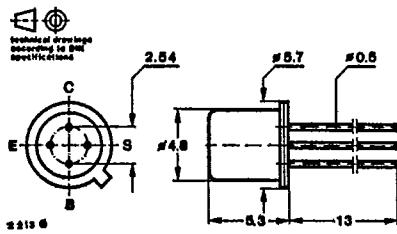
BF 184

Silicon NPN Epitaxial Planar RF Transistor

Applications: General and controlled RF amplifier stages up to 100 MHz

Features:

- Noise figure 3.5 dB
- Noise figure for mixer 2 dB

Dimensions in mm

Terminal "S"
 connected with case
 Case
 18 A 4 DIN 41876
 JEDEC TO 72
 Weight max. 0.5 g

Absolute maximum ratings

Collector-base voltage	V_{CBO}	30	V
Collector-emitter voltage	V_{CEO}	20	V
Emitter-base voltage	V_{EBO}	5	V
Collector current	I_C	30	mA
Base current	I_B	1	mA
Total power dissipation $T_{amb} \leq 45^\circ\text{C}$	P_{tot}	145	mW
Junction temperature	T_J	175	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 ... +175	$^\circ\text{C}$

Thermal resistances

	Min.	Typ.	Max.
Junction ambient		R_{thJA}	900 K/W

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DC characteristics

 $T_{amb} = 25^\circ C$

Collector-base breakdown voltage

 $I_C = 10 \mu A$

		Min.	Typ.	Max.
	$V_{(BR)CBO}$	30		V

Collector-emitter breakdown voltage

 $I_C = 2 mA$

		Min.	Typ.	Max.
	$V_{(BR)CEO}^1)$	20		V

Emitter-base breakdown voltage

 $I_E = 10 \mu A$

		Min.	Typ.	Max.
	$V_{(BR)EBO}$	5		V

Base-emitter voltage

 $V_{CE} = 10 V, I_C = 1 mA$ $V_{CE} = 2 V, I_C = 20 mA$

		650	680	740	mV
	$V_{BE}^1)$			1	V

DC forward current transfer ratio

 $V_{CE} = 10 V, I_C = 1 mA$

	h_{FE}	67	115	220

AC characteristics

 $T_{amb} = 25^\circ C$

Gain bandwidth product

 $V_{CB} = 10 V, I_C = 1 mA, f = 100 MHz$

	f_T	260		MHz

Feedback capacitance

 $V_{CB} = 10 V, I_C = 1 mA, f = 10.7 MHz$

	C_{ore}	0.65	0.9	pF

Noise figure

 $V_{CB} = 10 V, I_C = 1 mA, R_G = 300 \Omega, f = 200 kHz$

	F	1.45		dB

 $V_{CB} = 10 V, I_C = 1 mA, R_G = 50 \Omega, f = 1 MHz$

	F	3.5		dB

Noise figure for mixer

 $V_{CB} = 10 V, I_C = 1 mA, R_G = 1670 \Omega, f = 200 kHz$

	F_c	3		dB

 $V_{CB} = 10 V, I_C = 1 mA, R_G = 830 \Omega, f = 1 MHz$

	F_c	2		dB

Two port characteristics

 $T_{amb} = 25^\circ C$

Common emitter configuration

 $V_{CB} = 10 V, I_C = 1 mA, f = 0.45 MHz$

	g_{le}	0.35		mS
	C_{le}	23		pF

Short circuit reverse transfer admittance

	$ y_{re} $	1.8		μS
	$-\varphi_{re}$	90°		

Short circuit forward transfer admittance

	$ y_{fe} $	35		mS
	$-\varphi_{fe}$	$\approx 0^\circ$		

Short circuit output admittance

	g_{oe}	6		μS
	C_{oe}	1.45		pF

¹⁾ $\frac{t_p}{T} = 0.01, t_p = 0.3 ms$

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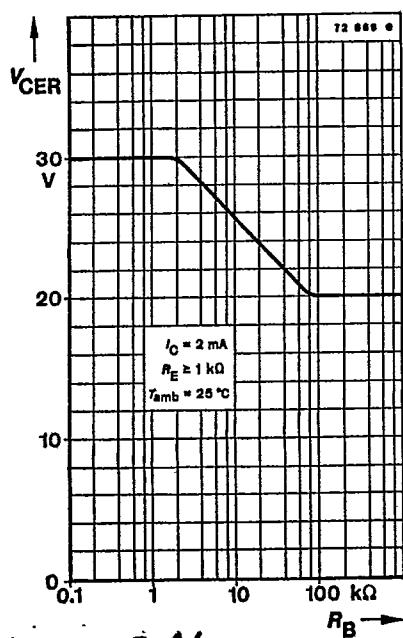
	Min.	Typ.	Max.
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Common emitter configuration $V_{CB} = 10 \text{ V}$, $I_C = 1 \text{ mA}$, $f = 10.7 \text{ MHz}$

Short circuit input admittance	g_{ie} C_{ie}	0.45 23	mS pF
Short circuit reverse transfer admittance	$ y_{re} $ $-\varphi_{re}$	44 90°	μS
Short circuit forward transfer admittance	$ y_{fe} $ $-\varphi_{fe}$	35 5°	mS
Short circuit output admittance	g_{oe} C_{oe}	8.5 1.5	μS pF

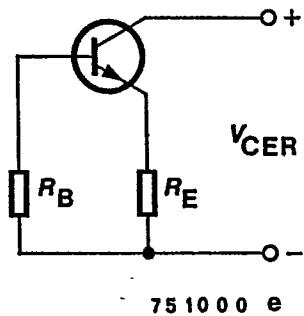
Common base configuration $V_{CB} = 10 \text{ V}$, $I_C = 1 \text{ mA}$, $f = 35 \text{ MHz}$

Short circuit input admittance	g_{ie} C_{ie}	0.85 19	mS pF
Short circuit reverse transfer admittance	$ y_{re} $ $-\varphi_{re}$	140 90°	μS
Short circuit forward transfer admittance	$ y_{fe} $ $-\varphi_{fe}$	34 16°	mS
Short circuit output admittance	g_{oe} C_{oe}	11 1.5	μS pF



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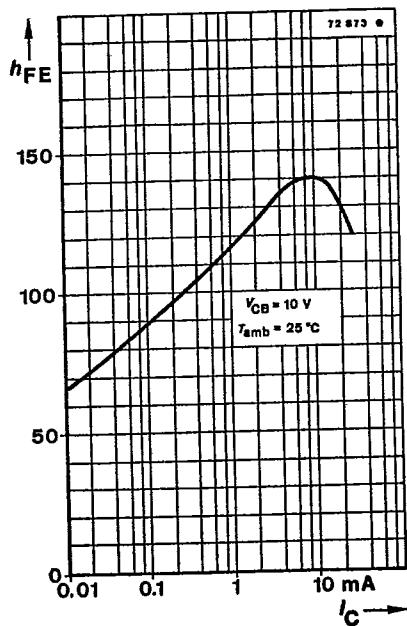
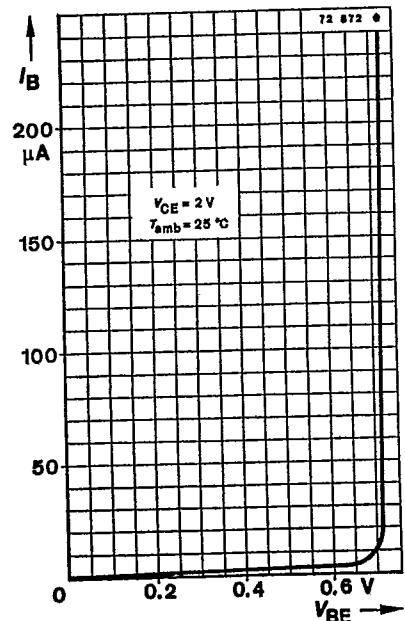
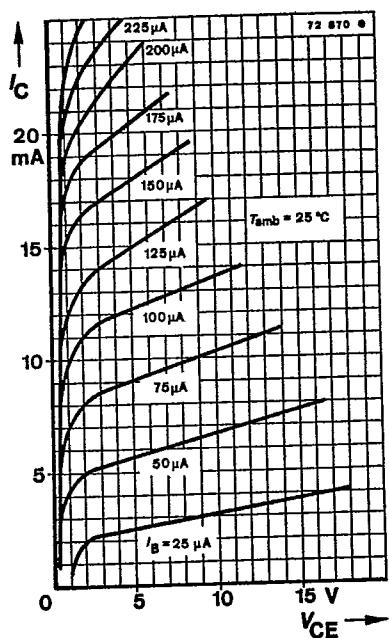
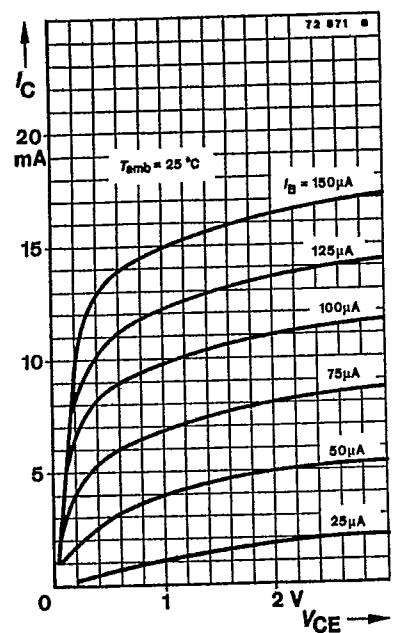
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7. Taping and Reeling

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7.1. Taping of TO-92 Transistors

Standard reeling: Taped on reel, reeled together with a paper film.

7.1.1. Order Numbers

Add the taping-code to the order number.

Example:

Order-No. of Type	BC 238 C	DU	06	Z
Code for TO-92 Transistors				
Orientation of transistor on tape ¹⁾				
Additional marking for specials ²⁾				

¹⁾ 06 = View on flat side of transistor, view on gummed tape

05 = View on round side of transistor, view on gummed tape

²⁾ Additional marking "0": taping without paper film

Additional marking "Z": Zigzag folded tape in special box. Marking for orientation of transistor not necessary, because box can be opened on top or bottom

Example for order No.: BC 237 C DU Z

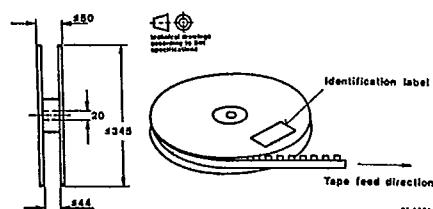


Fig. 7.1. Dimensions of reel in mm

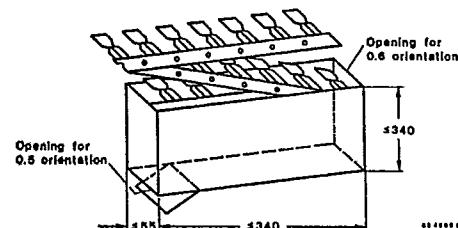


Fig. 7.2. Dimension of box for Zigzag folding in mm

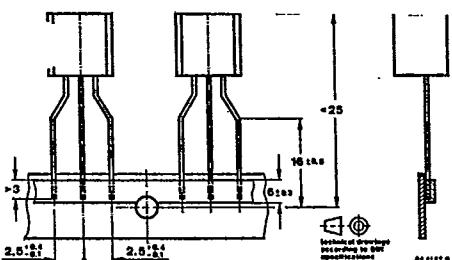


Fig. 7.3 Dimensions of tape in mm

7.1.2. Quantity of devices

1000 devices per reel
2000 devices per folded tape in special box.

7.2. Taped transistors in SOT 23 and SOT 143 case

7.2.1. Designation

a) Standard taping

Designation is attached with code GS 08 in case of standard taping. Example for normal version transistors as standard taped: BF 569-GS 08.

Example for R-version transistors as standard taped: BF 569 R-GS 08.

In case of standard taping, the transistor orientation on the tape is shown in Fig. 7.4 and Fig. 7.5.

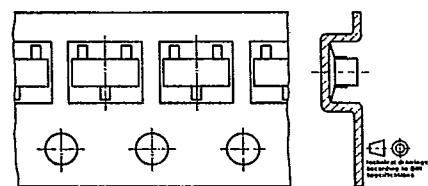


Fig. 7.4 Standard taped SOT 23

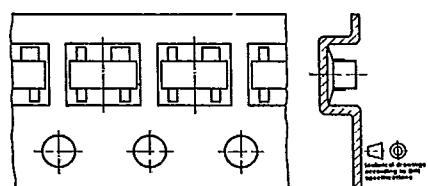


Fig. 7.5. Standard taped SOT 143

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b) Reverse taping

Designation is attached with code GS 07 in case of reverse taping. Example for normal version transistors as reverse taped: BF 569-GS 07.

Example for R-version transistors as reverse taping: BF 569 R-GS 07.

In case of reverse taping, the transistor orientation on the tape is shown in Fig. 7.6.

Regarding MOS-FET and MES-FET devices, reverse taping is at present not available.

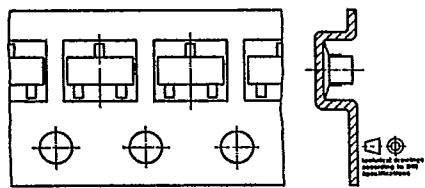


Fig. 7.6 Reverse taped SOT 23

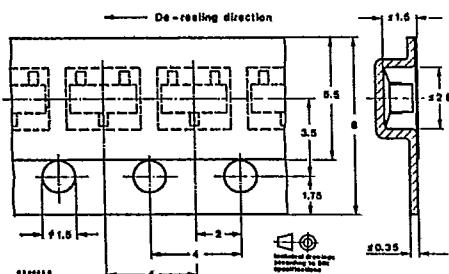


Fig. 7.7 Dimensions of tape in mm

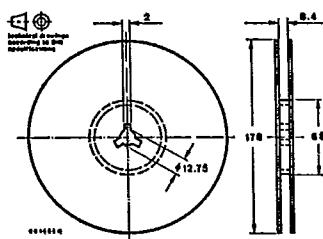


Fig. 7.8 Dimensions of reel in mm

7.2.2 Quantity of devices

3000 devices per reel